

#### Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com



### **Single Pair Ethernet PCB terminals**

Simple and efficient SPE solutions for the PCB

#### **Features and benefits:**

- Reliable data transmission at 10 Mbit/s up to 1,000 meters
- Suitable for all IIoT devices for easy integration of field devices. The SPE PCB components are a cost-effective alternative to standardized SPE connectors
- Optionally available with PUSH IN, SNAP IN or screw connection for high contact and vibration resistance
- Error-free installation of components thanks to appropriate markings.
- The PCB terminal blocks can be used as a two-pole variant for unshielded or as a three-pole variant for shielded applications
- Thanks to the "Power over Data Line" (PoDL) function, up to 50 W can be transmitted in accordance with IEEE 802.3bu



















#### **General ordering data**

Version	Printed circuit board terminals, block assembly, closed side, THT/THR solder connection, 5.00 mm, Number of poles: 3, Solder pin length (I): 3.5 mm, black, Tube
Order No.	<u>3077630000</u>
Туре	LSF-SMT SPE 5.00/03/135 3.5SN BK TU
GTIN (EAN)	4099987081832
Qty.	39 pc(s).
Packaging	Tube



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# **Technical data**

# **Dimensions and weights**

Depth	12.7 mm	Depth (inches)	0.5 inch
Height	16.4 mm	Height (inches)	0.646 inch
Height of lowest version	12.9 mm	Width	14.2 mm
Width (inches)	0.559 inch	Net weight	3.38 g

# **Temperatures**

Continuous operating temp., max. 120 °C

#### **System specifications**

Category	T1-B
Mounting onto the PCB	THT/THR solder connection
Number of poles	3
Number of solder pins per pole	2
Performance-Category	T1-B
Pitch in inches (P)	0.197 "
Pitch in mm (P)	5 mm
Protection degree	IP20
Side termination, characteristic	closed side
Solder eyelet hole diameter (D)	1.1 mm
Solder eyelet hole diameter tolerance (E	0)+ 0,1 mm
Solder pin dimensions	0.35 x 0.8 mm
Solder pin dimensions = d tolerance	Lower tolerance with prefix (reveals minimum) -0.1
	Upper tolerance with prefix (reveals maximum) 0
	Tolerance, unit mm
Solder pin length (I)	3.5 mm
Solder pin length tolerance	+0.1 / -0.3 mm
Solder pin length tolerance	Lower tolerance with prefix (reveals minimum) -0.3
	Upper tolerance with prefix (reveals maximum) +0.1
	Tolerance, unit mm
Soldering process	Reflow soldering, Manual soldering, Wave soldering

## **Electrical properties**

Volume resistance 1.60 mΩ

### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Copper alloy
Layer structure of solder connection	46 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	120 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	120 °C		

# **Packing**

Packaging	Tube	VPE length	555 mm
VPE width	21 mm	VPE height	17 mm
Surface resistance	$Rs = 10^9 - 10^{12} \Omega$		



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# **Technical data**

#### Classifications

ETIM 6.0	EC002643	ETIM 7.0	EC002643
ETIM 8.0	EC002643	ETIM 9.0	EC002643
ETIM 10.0	EC002643	ECLASS 9.0	27-44-04-01
ECLASS 9.1	27-44-04-01	ECLASS 10.0	27-44-04-01
ECLASS 11.0	27-46-01-01	ECLASS 12.0	27-46-01-01
ECLASS 13.0	27-46-01-01	ECLASS 14.0	27-46-01-01
ECLASS 15.0	27-46-01-01		

### **Environmental Product Compliance**

RoHS Compliance Status	Compliant without exemption
REACH SVHC	No SVHC above 0.1 wt%

# **Approvals**

ROHS	Conform

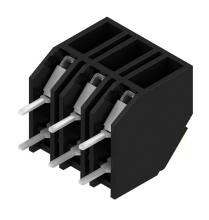


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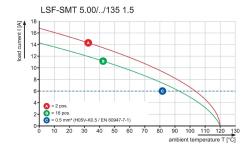
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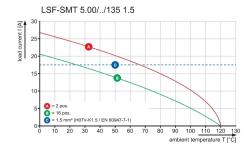
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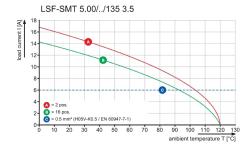
# **Drawings**

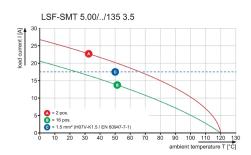














# Recommended wave solderding profiles

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# Single Wave:



#### **Double Wave:**



# Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.



# Recommended reflow soldering profile

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# Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.